ABBOGIATION CONNECTING ELECTRONICS INDUSTRIES INCOMPACTING	IPC. Bannockt	ourn. Illinois. A	Il rights reserved u ntions.	nder both	This docum level parts, t	ent is a declaration er	on of the substancompasses all	ances within the manufact lower level materials for	urer listed which the	item. Note: if manufacturer	the item is an as has engineering	ssembly with lower responsibility.	
			Form Type Distribute					erials and I	als and Mfg Information				
Supplier Information													
Company name* Compan			npany unique ID			Unique ID Authority				Response Date*			
onsemi										2025-09-12			
Contact Name Title - Contact			ct	Phone - Contact*				Email - Contact*					
Product-Env-Stewards Product Env			Enviro Compliance		NA			Produ	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repre			resentative		Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards Pr			Product Enviro Compliance			NA			Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	NSV1C2	NSV1C201LT1G NPN 100V SOT23		3 LOW V-SAT		2025-09-12	CN1			8.125	mg	Each	
Manufacturing Proccess Informa	ation												
Terminal Plating / Grid Array M	Material Terminal Base Alloy		Alloy J	-STD-020 MSI	L Rating	Peak Proce	ss Body Temp	erature Max Time at Pea	ık Temper	ature Numb	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy]	l		260	С	30	seco	onds 3				
Comments													
evel 1 - maximum time at peak temperat	ure during sol	Idering is 10-3	0 seconds										
or more information regarding materia	l composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ess of the applicable quantity limit identified about the may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member we independently verified such information. How	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.16	mg	Supplier	Silicon (Si)	7440-21-3		0.16	mg	
Lead Frame	2.92	mg	Supplier	Silver (Ag)	7440-22-4		0.5198	mg	
			В	Nickel (Ni)	7440-02-0		0.9023	mg	
			Supplier	Iron (Fe)	7439-89-6		1.2468	mg	
			Supplier	Copper (Cu)	7440-50-8		0.2511	mg	
Mold Compound-Black	4.9	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.49	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.0245	mg	
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.7105	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		3.185	mg	
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.49	mg	
Plating	0.14	mg	Supplier	Tin (Sn)	7440-31-5		0.14	mg	
Wire Bond - Cu	0.005	mg	Supplier	Copper (Cu)	7440-50-8		0.005	mg	